March 2016



FDB86566_F085

N-Channel PowerTrench® MOSFET **60 V, 110 A, 2.7 m**Ω

Features

- Typical $R_{DS(on)}$ = 2.2 m Ω at V_{GS} = 10V, I_D = 80 A
- Typical $Q_{q(tot)}$ = 80 nC at V_{GS} = 10V, I_D = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems







TO-263

MOSFET Maximum Ratings T_J = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-to-Source Voltage		60	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C = 25°C	110	^
I _D	Pulsed Drain Current	T _C = 25°C	See Figure 4	Α
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	193	mJ
D	Power Dissipation		176	W
P_D	Derate Above 25°C		1.2	W/°C
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.85	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W

- 1: Current is limited by bondwire configuration.
- 2: Starting T_J = 25°C, L = 50uH, I_{AS} = 88A, V_{DD} = 60V during inductor charging and V_{DD} = 0V during time in avalanche.
- 3: R_{0,JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB86566	FDB86566_F085	D2-PAK(TO-263)	330mm	24mm	800 units

Units

Max.

Electrical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted.

Parameter

Off Ch	Off Characteristics							
B _{VDSS}	Drain-to-Source Breakdown Voltage	$I_D = 250 \mu A$,	V _{GS} = 0V	60	-	-	V	
	Drain-to-Source Leakage Current	V _{DS} =60V,	$T_{\rm J} = 25^{\rm o}{\rm C}$	-	-	1	μΑ	
DSS	I _{DSS} Drain-to-Source Leakage Current		$T_J = 175^{\circ}C \text{ (Note 4)}$	-	-	1	mA	
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = ±20V		ı	-	±100	nA	

Test Conditions

Min.

Тур.

On Characteristics

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$		2.0	3.2	4.0	V
R _{DS(op)} Drain to Source On Resistance	I _D = 80A,	$T_{J} = 25^{\circ}C$	-	2.2	2.7	mΩ	
DS(on)	R _{DS(on)} Drain to Source On Resistance	V _{GS} = 10V	$T_J = 175^{\circ}C \text{ (Note 4)}$	-	4.1	5.0	mΩ

Dynamic Characteristics

C _{iss}	Input Capacitance	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{V},$ f = 1 MHz		-	6655	-	pF
C _{oss}	Output Capacitance			-	1745	-	pF
C _{rss}	Reverse Transfer Capacitance			-	57	-	pF
R_g	Gate Resistance	f = 1MHz		-	2.2	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	V_{GS} = 0 to 10V	V _{DD} = 30V	-	80	110	nC
$Q_{g(th)}$	Threshold Gate Charge	V_{GS} = 0 to 2V	I _D = 80A	-	12	-	nC
Q_{gs}	Gate-to-Source Gate Charge		_	-	35	-	nC
Q_{gd}	Gate-to-Drain "Miller" Charge			-	10	-	nC

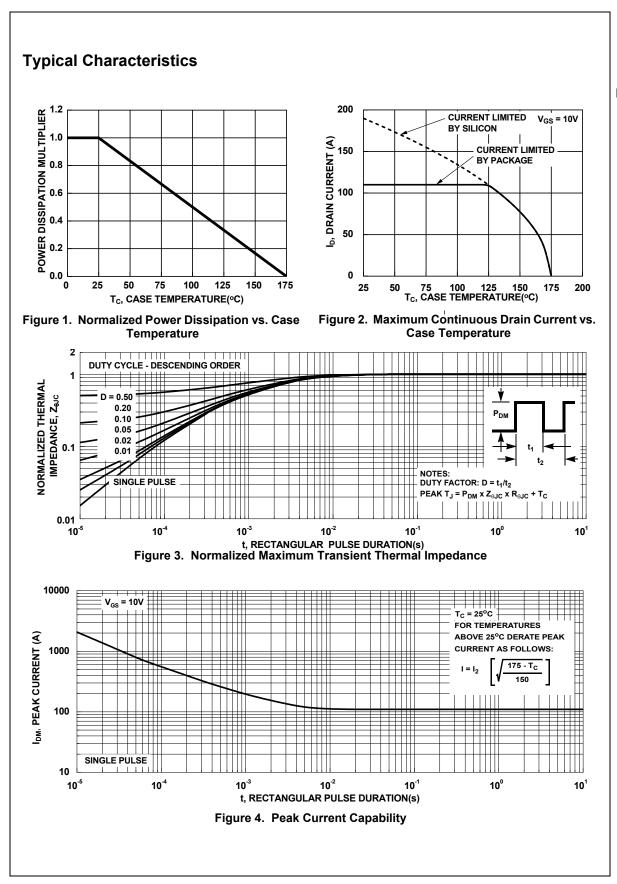
Switching Characteristics

t _{on}	Turn-On Time		-	-	115	ns
t _{d(on)}	Turn-On Delay		-	36	-	ns
t _r	Rise Time	V _{DD} = 30V, I _D = 80A,	-	52	-	ns
t _{d(off)}	Turn-Off Delay	V_{GS} = 10V, R_{GEN} = 6Ω	-	36	-	ns
t _f	Fall Time		-	13	-	ns
t _{off}	Turn-Off Time		-	-	64	ns

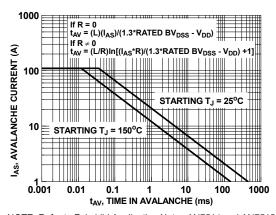
Drain-Source Diode Characteristics

V	Source-to-Drain Diode Voltage	I _{SD} =80A, V _{GS} = 0V	-	-	1.25	V
V_{SD}	Source-to-Drain blode voltage	$I_{SD} = 40A, V_{GS} = 0V$	-	-	1.2	٧
t _{rr}	Reverse-Recovery Time	$I_F = 80A$, $dI_{SD}/dt = 100A/\mu s$,	-	78	102	ns
Q _{rr}	Reverse-Recovery Charge	V _{DD} =48V	-	100	130	nC

4: The maximum value is specified by design at T_J = 175°C. Product is not tested to this condition in production.



Typical Characteristics ID, DRAIN CURRENT (A) 100 10 OPERATION IN THIS AREA MAY BE LIMITED BY rDS(on) 1ms 10ms T.I = MAX RATED 100ms T_C = 25^OC 0.1 10 100 200 V_{DS}, DRAIN TO SOURCE VOLTAGE (V) Figure 5. Forward Bias Safe Operating Area

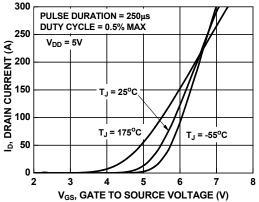


NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

perating Area Figure 6. Ur



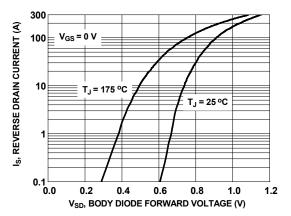
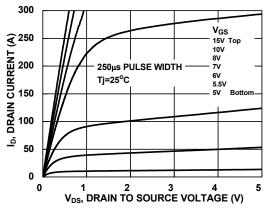


Figure 7. Transfer Characteristics

Figure 8. Forward Diode Characteristics



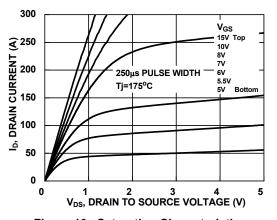


Figure 9. Saturation Characteristics

Figure 10. Saturation Characteristics

Typical Characteristics

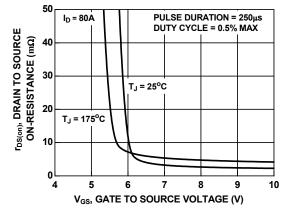


Figure 11. R_{DSON} vs. Gate Voltage

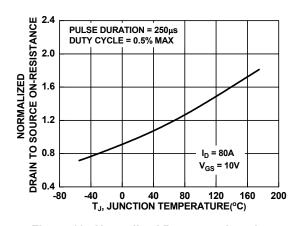


Figure 12. Normalized R_{DSON} vs. Junction Temperature

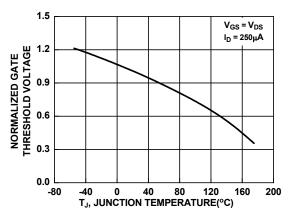


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

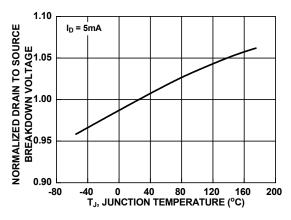


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

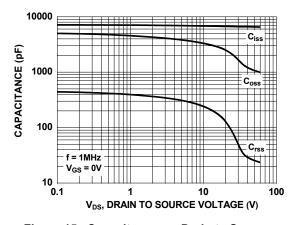


Figure 15. Capacitance vs. Drain to Source Voltage

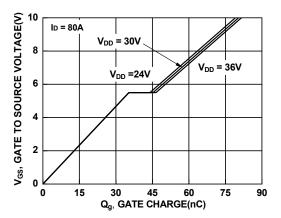


Figure 16. Gate Charge vs. Gate to Source Voltage





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